# onsemi

# MOSFET - Power, Single N-Channel 100 V, 2.8 mΩ, 177 A NVMFWS002N10MCL

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free, Beryllium Free and are RoHS Compliant

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	100	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain Current $R_{\theta JC}$ (Note 1)	Steady State	$T_C = 25^{\circ}C$	I <sub>D</sub>	177	А
		$T_C = 100^{\circ}C$		125	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_C = 25^{\circ}C$	PD	194	W
		$T_C = 100^{\circ}C$		97	
Continuous Drain		T <sub>A</sub> = 25°C	I <sub>D</sub>	25	А
Current R <sub>θJA</sub> (Notes 1, 2)	Steady	T <sub>A</sub> = 100°C		18	
Power Dissipation	State	$T_A = 25^{\circ}C$	PD	3.8	W
R <sub>θJA</sub> (Notes 1, 2)		T <sub>A</sub> = 100°C		1.9	
Pulsed Drain Current	$T_A = 25^\circ C$ , $t_p = 10 \ \mu s$		I <sub>DM</sub>	900	А
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C	
Source Current (Body Diode)		۱ <sub>S</sub>	149	А	
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 11.9 A)		E <sub>AS</sub>	1338	mJ	
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

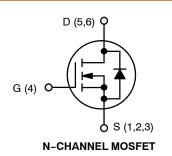
#### THERMAL RESISTANCE RATINGS

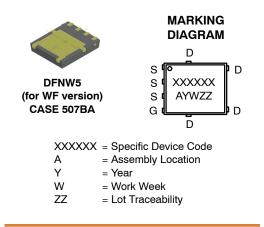
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.77	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using 1 in<sup>2</sup> pad size, 2 oz. Cu pad.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
100 V	2.8 mΩ @ 10 V	177 A
	3.8 mΩ @ 4.5 V	177 A





#### **ORDERING INFORMATION**

Device	Package	Shipping†	
NVMFWS002N10MCLT1G (Wettable Flanks)	DFN5 (Pb-Free)	1500 / Tape & Reel	

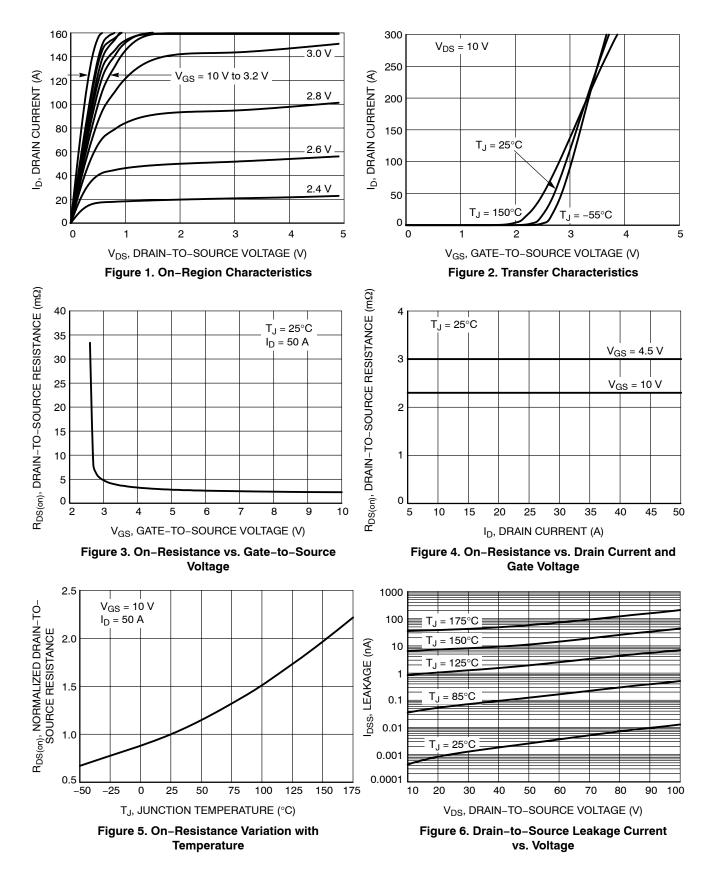
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

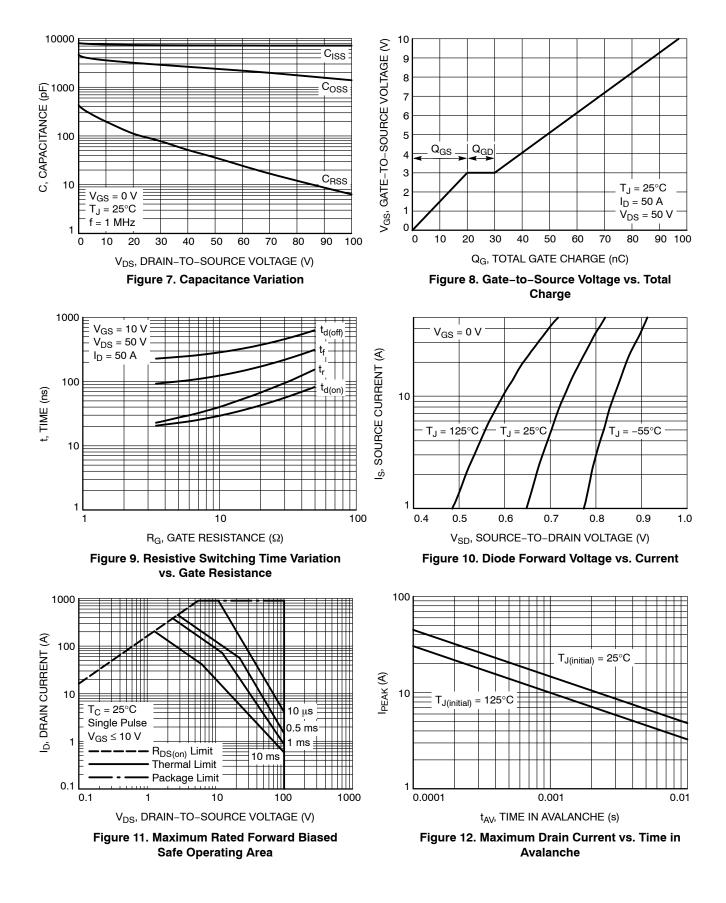
Parameter	Symbol	Test Cond	ition	Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D =$	= 250 μA	100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>	I <sub>D</sub> = 250 μA, ref to 25°C			70		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V	$T_J = 25^{\circ}C$			1	μA
			T <sub>J</sub> = 125°C			100	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>G</sub>	<sub>S</sub> = 20 V			100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub>	= 351 μA	1		3	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>	$I_{\rm D} = 250 \mu \text{A}$ , ref to 25°C			-5.7		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I	<sub>D</sub> = 50 A		2.3	2.8	mΩ
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 50 A			3.0	3.8	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 50 A			200		S
Gate-Resistance	R <sub>G</sub>	T <sub>A</sub> = 25°C			0.40		Ω
CHARGES & CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 50 V			7200		pF
Output Capacitance	C <sub>OSS</sub>				2400		
Reverse Transfer Capacitance	C <sub>RSS</sub>				36		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 50 V, $I_{D}$ = 50 A			45		nC
Total Gate Charge	Q <sub>G(TOT)</sub>				97		1
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 50 V, I <sub>D</sub> = 50 A			11		-
Gate-to-Source Charge	Q <sub>GS</sub>				20		
Gate-to-Drain Charge	Q <sub>GD</sub>				10		
Plateau Voltage	V <sub>GP</sub>				3		V
SWITCHING CHARACTERISTICS (Note :	3)						
Turn–On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 50 V, $I_{D}$ = 50 A, $R_{G}$ = 6 $\Omega$			24		ns
Rise Time	t <sub>r</sub>				30		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				250		
Fall Time	t <sub>f</sub>				105		
DRAIN-SOURCE DIODE CHARACTERIS	STICS				<u> </u>		
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 50 A	$T_J = 25^{\circ}C$		0.83	1.3	V
			T <sub>J</sub> = 125°C		0.71		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 31 A			73		ns
Reverse Recovery Charge	Q <sub>RR</sub>				93		nC
Charge Time	t <sub>a</sub>				35		ns
Discharge Time	t <sub>b</sub>				38		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.3. Switching characteristics are independent of operating junction temperatures

#### **TYPICAL CHARACTERISTICS**



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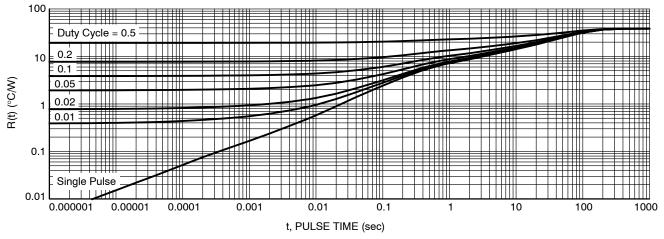
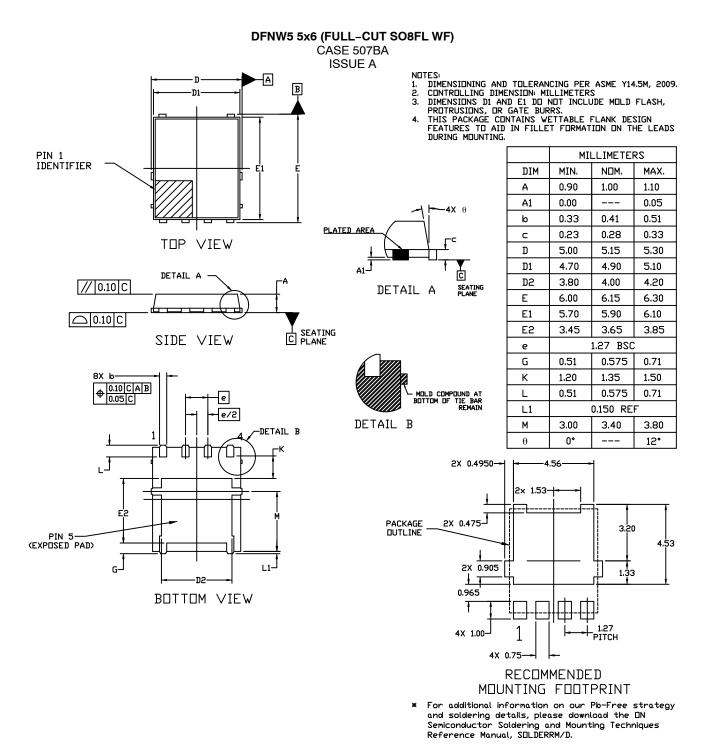


Figure 13. Transient Thermal Impedance

#### PACKAGE DIMENSIONS



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